

PATENT NUMBER

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**U.S. UTILITY** Patent Application

O.I.P.E. *WJ*  
SCANNED *HKM 3* Q.A.

PATENT DATE

SCANNED 11/11/2023 Q.A.

APPLICATION NO. 09/963267	CONT/PRIOR F	CLASS 257	SUBCLASS 678	ART UNIT <del>2811</del> 2822	EXAMINER SOWARD
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## APPLICANTS

**TITLE**

~~Semiconductor device and manufacturing method thereof~~

PTO-2040  
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